

SN74ALVCH162601

18-BIT UNIVERSAL BUS TRANSCEIVER

WITH 3-STATE OUTPUTS

SCES026B – JULY 1995 – REVISED FEBRUARY 1997

- Member of the Texas Instruments *Widebus™* Family
- *EPIC™* (Enhanced-Performance Implanted CMOS) Submicron Process
- *UBT™* (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, Clocked, or Clock-Enabled Mode
- Output Ports Have Equivalent 26-Ω Series Resistors, So No External Resistors Are Required
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 18-bit universal bus transceiver is designed for 2.3-V to 3.6-V V_{CC} operation.

The SN74ALVCH162601 combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, clocked, and clock-enabled modes.

Data flow in each direction is controlled by output-enable (\overline{OEAB} and \overline{OEBA}), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock can be controlled by the clock-enable ($\overline{CLKENAB}$ and $\overline{CLKENBA}$) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. When \overline{OEAB} is low, the outputs are active. When \overline{OEAB} is high, the outputs are in the high-impedance state.

Data flow for B to A is similar to that of A to B but uses \overline{OEBA} , LEBA, CLKBA, and $\overline{CLKENBA}$.

The B-port outputs include equivalent 26-Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

The SN74ALVCH162601 is characterized for operation from -40°C to 85°C.

DGG OR DL PACKAGE
(TOP VIEW)

OEAB	1	56	CLKENAB
LEAB	2	55	CLKAB
A1	3	54	B1
GND	4	53	GND
A2	5	52	B2
A3	6	51	B3
V _{CC}	7	50	V _{CC}
A4	8	49	B4
A5	9	48	B5
A6	10	47	B6
GND	11	46	GND
A7	12	45	B7
A8	13	44	B8
A9	14	43	B9
A10	15	42	B10
A11	16	41	B11
A12	17	40	B12
GND	18	39	GND
A13	19	38	B13
A14	20	37	B14
A15	21	36	B15
V _{CC}	22	35	V _{CC}
A16	23	34	B16
A17	24	33	B17
GND	25	32	GND
A18	26	31	B18
OEBA	27	30	CLKBA
LEBA	28	29	CLKENBA



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FUNCTION TABLE†

INPUTS					OUTPUT B
CLKENAB	OEAB	LEAB	CLKAB	A	
X	H	X	X	X	Z
X	L	H	X	L	L
X	L	H	X	H	H
H	L	L	X	X	B ₀ ‡
H	L	L	X	X	B ₀ ‡
L	L	L	↑	L	L
L	L	L	↑	H	H
L	L	L	L	X	B ₀ ‡
L	L	L	H	X	B ₀ §

† A-to-B data flow is shown; B-to-A flow is similar but uses OEBA, LEBA, CLKBA, and CLKENBA.

‡ Output level before the indicated steady-state input conditions were established

§ Output level before the indicated steady-state input conditions were established, provided that CLKAB is low before LEAB goes low

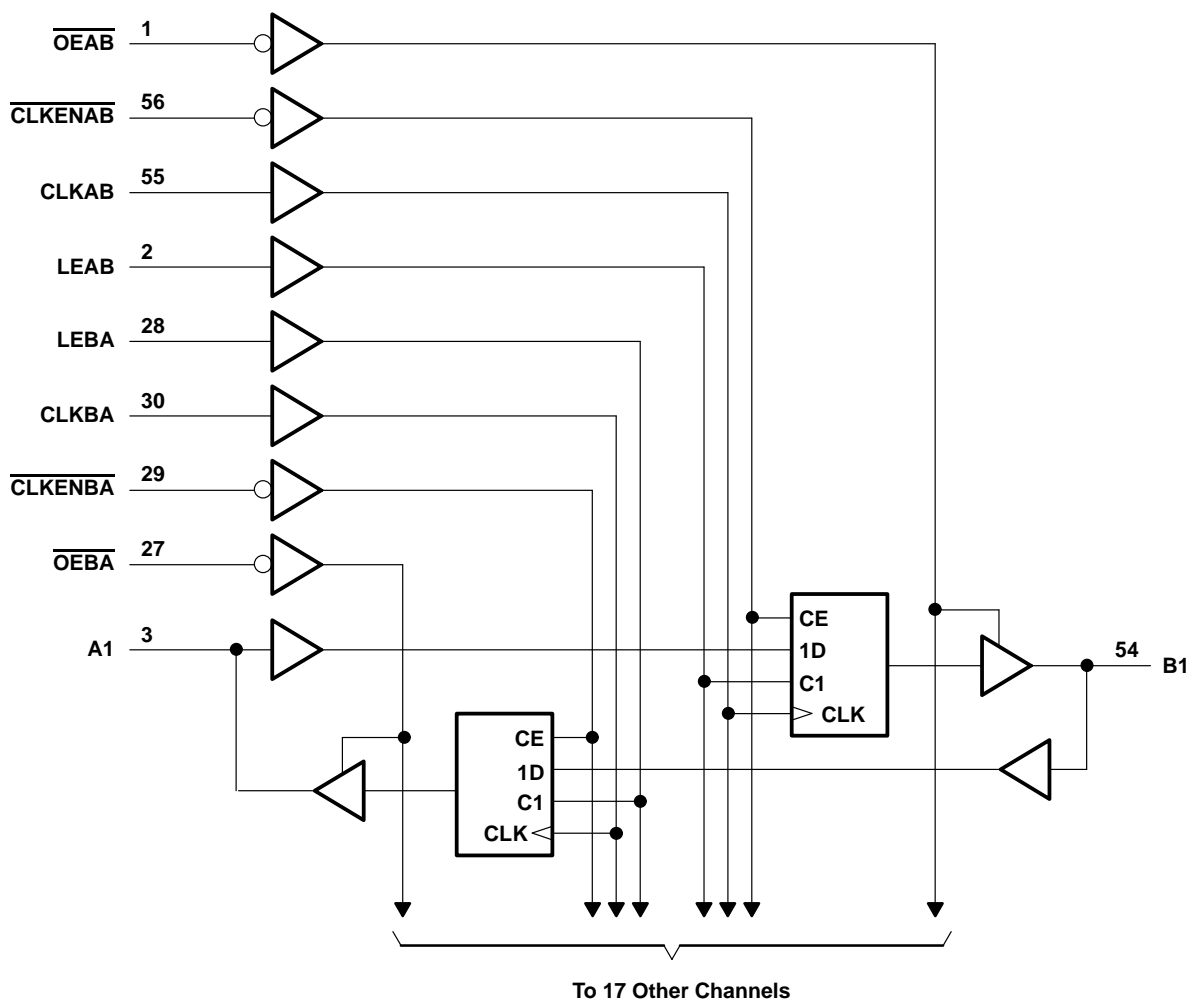


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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 4.6 V
Input voltage range, V_I : Except I/O ports (see Note 1)	–0.5 V to 4.6 V
I/O ports (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Output voltage range, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through each V_{CC} or GND	±100 mA
Package thermal impedance, θ_{JA} (see Note 3): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 4.6 V maximum.
3. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.



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recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
V _{CC}	Supply voltage		2.3	3.6	V
V _{IH}	High-level input voltage	V _{CC} = 2.7 V to 3.6 V	2		V
		V _{CC} = 2.3 V to 2.7 V	1.7		
V _{IL}	Low-level input voltage	V _{CC} = 2.7 V to 3.6 V		0.8	V
		V _{CC} = 2.3 V to 2.7 V		0.7	
V _I	Input voltage		0	V _{CC}	V
V _O	Output voltage		0	V _{CC}	V
I _{OH}	High-level output current (A port)	V _{CC} = 2.3 V		−12	mA
		V _{CC} = 2.7 V		−12	
		V _{CC} = 3 V		−24	
I _{OL}	Low-level output current (A port)	V _{CC} = 2.3 V		12	mA
		V _{CC} = 2.7 V		12	
		V _{CC} = 3 V		24	
I _{OH}	High-level output current (B port)	V _{CC} = 2.3 V		−6	mA
		V _{CC} = 2.7 V		−8	
		V _{CC} = 3 V		−12	
I _{OL}	Low-level output current (B port)	V _{CC} = 2.3 V		6	mA
		V _{CC} = 2.7 V		8	
		V _{CC} = 3 V		12	
Δt/Δv	Input transition rise or fall rate		0	10	ns/V
T _A	Operating free-air temperature		−40	85	°C

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V _{CC}	MIN	TYP†	MAX	UNIT
V _{OH}	B port	I _{OH} = -100 µA	2.3 V to 3.6 V	V _{CC} - 0.2			V
		I _{OH} = -4 mA, V _{IH} = 1.7 V	2.3 V	1.9			
		I _{OH} = -6 mA	V _{IH} = 1.7 V	2.3 V	1.7		
			V _{IH} = 2 V	3 V	2.4		
		I _{OH} = -8 mA, V _{IH} = 2 V	2.7 V	2			
		I _{OH} = -12 mA, V _{IH} = 2 V	3 V	2			
	A port	I _{OH} = -100 µA	2.3 V to 3.6 V	V _{CC} - 0.2			
		I _{OH} = -6 mA, V _{IH} = 1.7 V	2.3 V	2			
		I _{OH} = -12 mA	V _{IH} = 1.7 V	2.3 V	1.7		
			V _{IH} = 2 V	2.7 V	2.2		
			3 V	2.4			
		I _{OH} = -24 mA, V _{IH} = 2 V	3 V	2			
V _{OL}	B port	I _{OL} = 100 µA	2.3 V to 3.6 V			0.2	V
		I _{OL} = 4 mA, V _{IL} = 0.7 V	2.3 V			0.4	
		I _{OL} = 6 mA	V _{IL} = 0.7 V	2.3 V		0.55	
			V _{IL} = 0.8 V	3 V		0.55	
		I _{OL} = 8 mA, V _{IL} = 0.8 V	2.7 V			0.6	
		I _{OL} = 12 mA, V _{IL} = 0.8 V	3 V			0.8	
	A port	I _{OL} = 100 µA	2.3 V to 3.6 V			0.2	
		I _{OL} = 6 mA, V _{IL} = 0.7 V	2.3 V			0.4	
		I _{OL} = 12 mA	V _{IL} = 0.7 V	2.3 V		0.7	
			V _{IL} = 0.8 V	2.7 V		0.4	
		I _{OL} = 24 mA, V _{IL} = 0.8 V	3 V			0.55	
I _I		V _I = V _{CC} or GND	3.6 V			±5	µA
I _{I(hold)}		V _I = 0.7 V	2.3 V	45			µA
		V _I = 1.7 V	2.3 V	-45			
		V _I = 0.8 V	3 V	75			
		V _I = 2 V	3 V	-75			
		V _I = 0 to 3.6 V‡	3.6 V			±500	
I _{OZ} §		V _O = V _{CC} or GND	3.6 V			±10	µA
I _{CC}		V _I = V _{CC} or GND, I _O = 0	3.6 V			40	µA
ΔI _{CC}		One input at V _{CC} - 0.6 V, Other inputs at V _{CC} or GND	3 V to 3.6 V			750	µA
C _i	Control inputs	V _I = V _{CC} or GND	3.3 V		4		pF
C _{io}	A or B ports	V _O = V _{CC} or GND	3.3 V		8		pF

† Typical values are measured at V_{CC} = 3.3 V, T_A = 25°C.

‡ This is the bus-hold maximum dynamic current required to switch the input from one state to another.

§ For I/O ports, the parameter I_{OZ} includes the input leakage current.



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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

				V _{CC} = 2.5 V ± 0.2 V		V _{CC} = 2.7 V		V _{CC} = 3.3 V ± 0.3 V		UNIT
				MIN	MAX	MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency			0	140	0	150	0	150	MHz
t _w	Pulse duration	LE high		3.3		3.3		3.3		ns
		CLK high or low		3.3		3.3		3.3		
t _{su}	Setup time	Data before CLK high		2.3		2.4		2.1		ns
		Data before LE low	CLK high	2		1.6		1.6		
			CLK low	1.3		1.2		1.1		
		CLKEN before CLK high		2		2		1.7		
t _h	Hold time	Data after CLK high		0.7		0.7		0.8		ns
		Data after LE low	CLK high	1.3		1.6		1.4		
			CLK low	1.7		2		1.7		
		CLKEN after CLK high		0.3		0.5		0.6		

switching characteristics over recommended operating free-air temperature range, $C_L = 50\text{ pF}$ (unless otherwise noted) (see Figures 1 and 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 2.5\text{ V}$ $\pm 0.2\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V}$ $\pm 0.3\text{ V}$		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
f_{max}			140		150		150		MHz
t_{pd}	A	B	1.8	5.4	5.2	1.6	4.5		ns
	B	A	1.3	4.9	4.6	1	4.1		
	LEAB	B	1.5	6.1	5.9	1.5	5.1		
	LEBA	A	1.4	5.6	5.3	1	4.7		
	CLKAB	B	2	6.7	6.3	1.6	5.5		
	CLKBA	A	1.8	6.2	5.8	1.4	5		
t_{en}	$\overline{\text{OEAB}}$	B	1.7	6.6	6.7	1.6	5.7		ns
t_{dis}			2.5	5.9	5.3	1.8	4.8		
t_{en}	$\overline{\text{OEBA}}$	A	1.2	6	6.1	1.1	5.2		ns
t_{dis}			2.1	5.4	4.8	1.6	4.4		

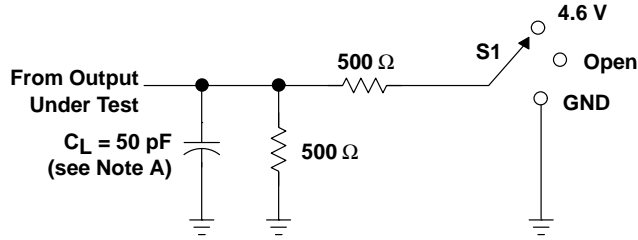
operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER			TEST CONDITIONS	VCC = 2.5 V ± 0.2 V	VCC = 3.3 V ± 0.3 V	UNIT
				TYP	TYP	
Cpd	Power dissipation capacitance	Outputs enabled	CL = 50 pF, f = 10 MHz	41	50	pF
		Outputs disabled		6	6	



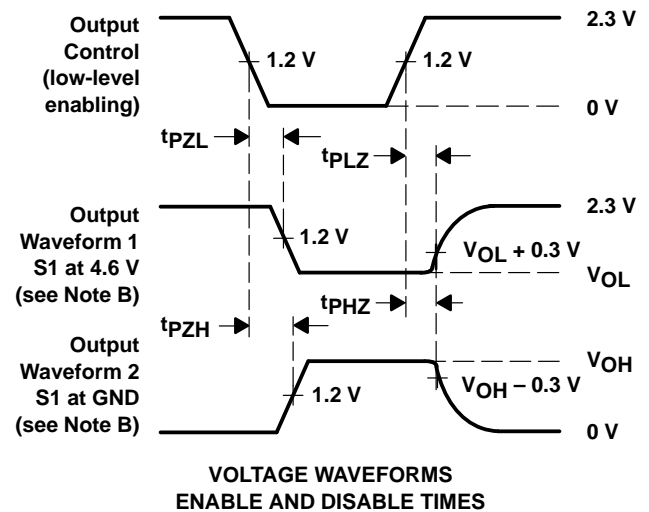
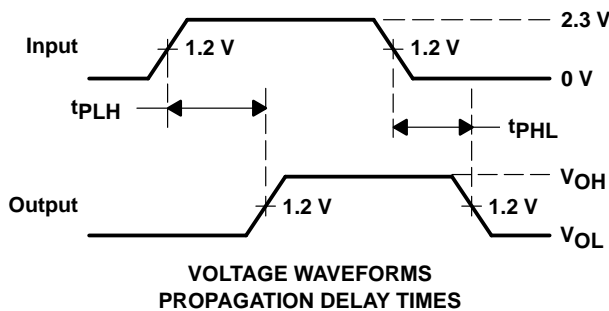
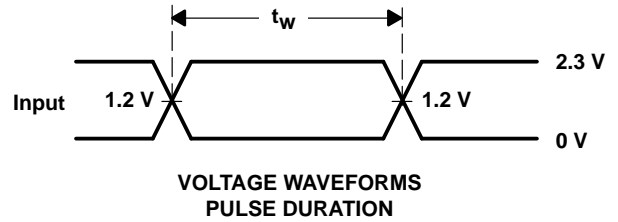
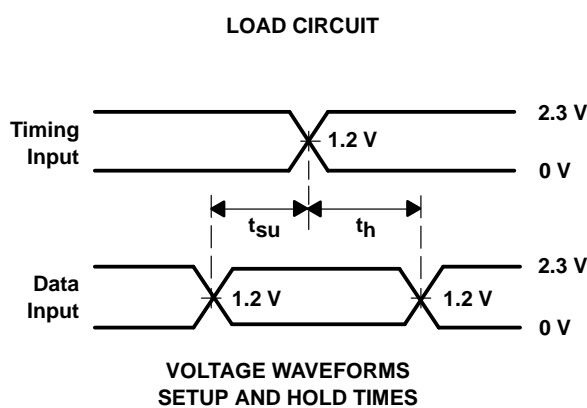
PARAMETER MEASUREMENT INFORMATION

$$V_{CC} = 2.5 \text{ V} \pm 0.2 \text{ V}$$



LOAD CIRCUIT

TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	4.6 V
t_{PHZ}/t_{PZH}	GND



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PHL} and t_{PLH} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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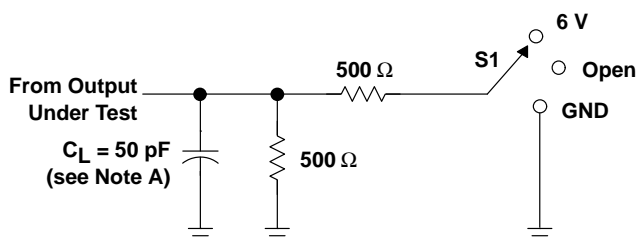
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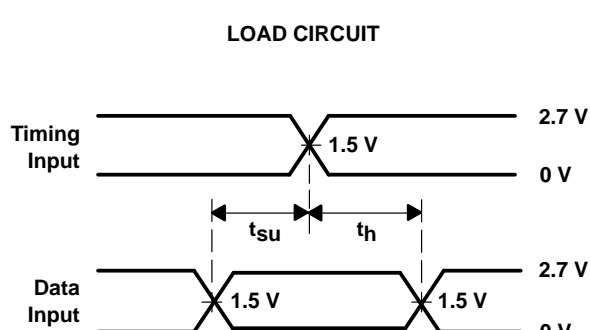
PARAMETER MEASUREMENT INFORMATION

$V_{CC} = 2.7\text{ V AND } 3.3\text{ V} \pm 0.3\text{ V}$

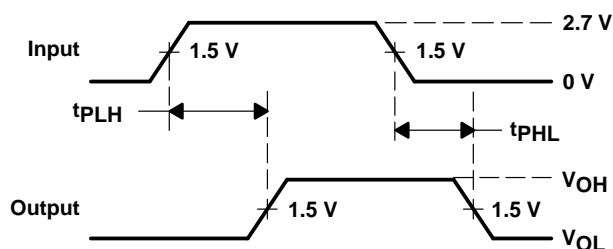


LOAD CIRCUIT

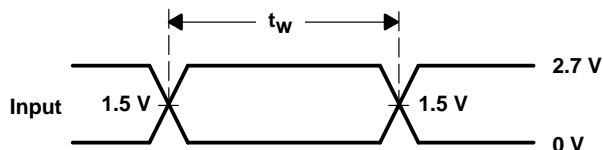
TEST	S1
t_{pd}	Open
t_{PLZ}/t_{PZL}	6 V
t_{PHZ}/t_{PZH}	GND



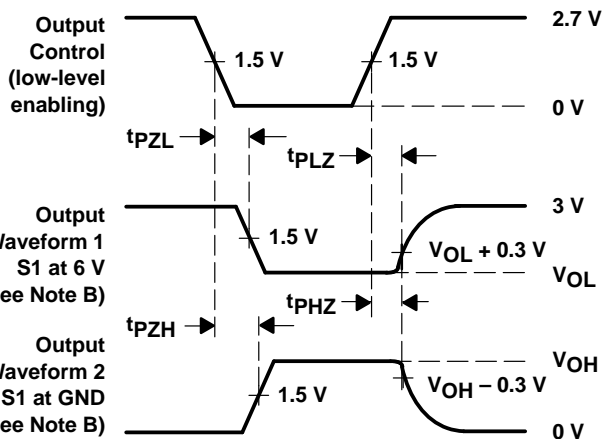
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10\text{ MHz}$, $Z_O = 50\text{ }\Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.
 - The outputs are measured one at a time with one transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PHL} and t_{PLH} are the same as t_{pd} .

Figure 2. Load Circuit and Voltage Waveforms

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